High Voltage Chips Capacitors

C Series

According to

Available space ranges:
consult our detail specifications

FEATURES

- Multilayer chip ceramic capacitors
- Size 1515 to 16080
- NP0, C4xx and X7R dielectrics
- Capacitance range: 10pf to 39 µF
- Voltage range: 200 V_{DC} to 10,000 V_{DC}

PHYSICAL CHARACTERISTICS

CONSTRUCTION

- C Series: Unleaded chip capacitors for surface mounting with optional tinning.
- P, PL, L models: DIL leaded uncoated chip capacitors for surface mounting recommended to eliminate thermomechanical stresses.
- N, NU models: DIL leaded chip capacitors for through-hole circuits (N: varnished chips, NU: uncoated chips).
- R, RU models: Ribbon leaded chip capacitors for surface mounting (R: varnished chips, RU: uncoated chips) recommended to eliminate thermomechanical stresses.

MARKING (On request on unleaded chips)

Series, capacitance value, tolerance, rated voltage clear or coded, date code.

ELECTRICAL SPECIFICATIONS

Dielectric	NP0	C4xx	X7R
Dielectric code	**1**	**4**	**2**
Maximum ΔC/°C over temperature range without voltage	NA	NA	±15%
Temperature coefficient	(0±30) ppm/°C	(−2,200±500) ppm/°C	NA
Aging	None	None	≤ 2.5% per decade hour
Operating temperature	−55°C to +125°C		
Rated voltage (U_{RC})	200 V_{DC} to 10,000 V_{DC}	200 V_{DC} to 5,000 V_{DC}	200 V_{DC} to 10,000 V_{DC}
Dielectric withstanding voltage	2.5 U_{RC} for U_{RC} ≤ 500 V_{DC} 1.6 U_{RC} for U_{RC} ≥ 1,000 V_{DC} **Extended range:** 2 U_{RC} for U_{RC} ≤ 500 V_{DC} 1.3 U_{RC} for U_{RC} ≥ 1,000 V_{DC}	2.5 U_{RC} for = 200 V_{DC} 2 U_{RC} for U_{RC} = 500 V_{DC} 1.5 U_{RC} for U_{RC} = 1,000 V_{DC} 1.4 U_{RC} for U_{RC} > 1,000 V_{DC} **Extended range:** 1.5 U_{RC} for U_{RC} ≤ 500 V_{DC} 1.2 U_{RC} for U_{RC} ≥ 1,000 V_{DC}	2.5 U_{RC} for U_{RC} = 200 V_{DC} 2 U_{RC} for U_{RC} = 500 V_{DC} 1.5 U_{RC} for U_{RC} = 1,000 V_{DC} 1.2 U_{RC} for U_{RC} > 1,000 V_{DC} **Extended range:** 1.5 U_{RC} for U_{RC} ≤ 500 V_{DC} 1.2 U_{RC} for U_{RC} ≥ 1,000 V_{DC}
Capacitance	at 1MHz for C ≤ 1,000pf at 1kHz for C > 1,000pf	at 1kHz	at 1kHz
Dissipation factor	≤ 0.015 (150/C + 7)% at 1MHz for C ≤ 50pf ≤ 0.15% at 1MHz for 50pf < C ≤ 1,000pf ≤ 0.15% at 1kHz for C > 1,000pf	≤ 0.10% at 1kHz	≤ 2.5% at 1kHz
Insulation resistance at 25°C under U_{RC} for U_{RC} ≤ 500V_{DC} under 500V_{DC} for U_{RC} > 500V_{DC}	≥ 100,000 MΩ for C ≤ 10nf ≥ 1,000 MΩ.µF for C > 10nf	≥ 20,000 MΩ for C ≤ 25nf ≥ 500 MΩ.µF for C > 25nf	

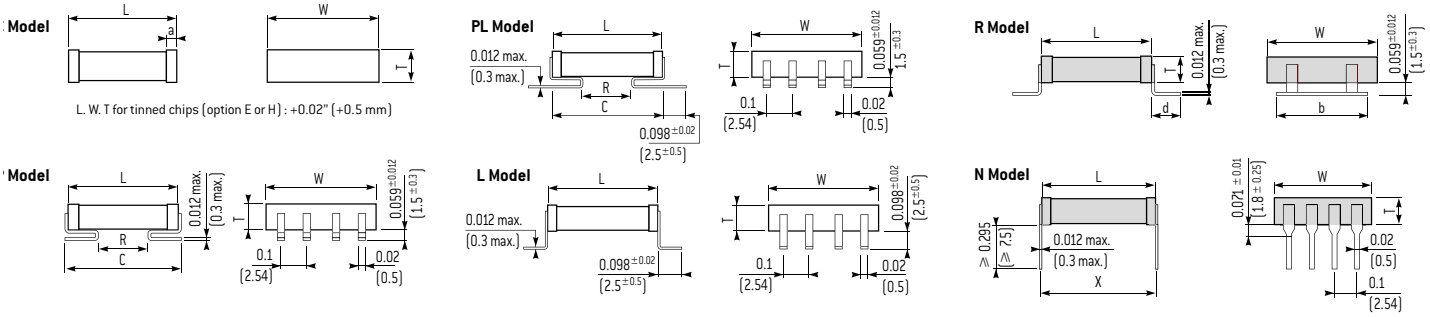
HIGH VOLTAGE

C	2	80	C	P	M	F	1µF	10%	200V	S12	T5
Series	Dielectric	Exxelia size code	Termination (Bare chips only)	Leads style + finishing (Leaded chips only)	Marking	Quality level	Capacitance	Tolerance	Rated voltage	Packaging	Reliability level
C = High voltage chip capacitor	**1** = NP0 **2** = X7R **4** = C4xx	**78** = 1515 **79** = 1812 **90** = 1825 **80** = 2220 **91** = 2225 **81** = 2825 **82** = 3333 **83** = 4040 **84** = 5440 **89** = 5550 **85** = 6560 **87** = 11283 **88** = 16080	**W** = RoHS compliant For all sizes **-** Ag/Pd/Pt; **W** Ag/Pd/Pt **Q** wAg; **QW** Ag From 1812 to 3333 sizes **-** Ag/Pd/Pt; **W** Ag/Pd/Pt **H** Ag/Pd/Pt + dipped Sn/Pb 60/40; **HW** Ag/Pd/Pt + dipped Sn **E** Ni + dipped Sn/Pb 60/40; **EW** Ni + dipped Sn **C** Ni + electrolytic Sn/Pb 95/5; **CW** Ni + electrolytic Sn **D** Ag + Ni + electrolytic Sn/Pb 60/40; **-** **G** Ni + electrolytic Gold; **-** From 1812 to 4040 sizes **YC** Ag + Polymer + Ni + Sn/Pb 95/5; **YCW** Ag + Polymer + Ni + Sn **YD** Ag + Polymer + Ni + Sn/Pb 60/40; **-** **YG** Ag + Polymer + Ni + Au; **YGW** Ag + Polymer + Ni + Au	**P** **PW** - RoHS **PL** **PLW** - RoHS **L** **LW** - RoHS **R** **RW** - RoHS **RU** **RUW** - RoHS **N** **NW** - RoHS **NU** **NUW** - RoHS not available for sizes 1515 and 1812	Only for unleaded chips (Leaded chips are always marked). **-** = no marking **M** = Marking: For sizes 1515 - 1825: Cap. value. For other sizes: EFD, Series, cap. value, tolerance, rated voltage, date code.	**-** = standard quality level **F** = Hi-Rel quality: screening in accordance with Exxelia specification	Capacitance value in clear	For NP0 dielectric: **±1%** **±2%** **±5%** **±10%** **±20%** For C4xx dielectric: **±2%** **±5%** **±10%** **±20%** For X7R dielectric: **±10%** **±20%**	**200V** **500V** **1,000V** **1,500V** **2,000V** **3,000V** **4,000V** **5,000V** **7,500V** **10,000V** Intermediary and higher voltages available on request.	**-** = Exxelia packaging (leaded chips : thermoformed packaging) Only available for unleaded chips: Sizes 1515 - 2220: **S12** = Super 12 reel Sizes 1812 and 2220 **BA** = Tray package (non oriented chips) **BAO** = Tray package (oriented chips) See page 13	For F parts only. Acc. to Exxelia spec. **-** **T5** **T6** See page 15

C Series

High Voltage Chips Capacitors

DIMENSIONS in inches (mm)



STANDARD RATINGS

	Size	1515	1812	1825	2220	2225	2825	3333
	Exxelia size code	78	79	90	80	91	81	82
Dimensions inches (mm)	L*	0.15 ± 0.015 (3.8 ± 0.38)	0.177 ± 0.020 (4.5 ± 0.5)	0.177 ± 0.020 (4.5 ± 0.5)	0.224 ± 0.020 (5.7 ± 0.5)	0.224 ± 0.020 (5.7 ± 0.5)	0.276 ± 0.020 (7 ± 0.5)	0.331 ± 0.020 (8.4 ± 0.5)
	W*	0.15 ± 0.015 (3.8 ± 0.38)	0.126 ± 0.020 (3.2 ± 0.5)	0.250 ± 0.020 (6.35 ± 0.5)	0.197 ± 0.020 (5.0 ± 0.5)	0.250 ± 0.020 (6.35 ± 0.5)	0.250 ± 0.020 (6.35 ± 0.5)	0.331 ± 0.020 (8.4 ± 0.5)
	a	0.012 min (0.3 min)	0.024 ± 0.020 (0.6 ± 0.5)	0.024 ± 0.020 (0.6 ± 0.5)	0.028 ± 0.020 (0.7 ± 0.5)	0.028 ± 0.020 (0.7 ± 0.5)	0.039 ± 0.020 (1 ± 0.5)	0.039 ± 0.020 (1 ± 0.5)
	d	- -	- -	0.087 ± 0.008 (2.2 ± 0.2)	0.087 ± 0.008 (2.2 ± 0.2)	0.087 ± 0.008 (2.2 ± 0.2)	0.087 ± 0.008 (2.2 ± 0.2)	0.138 ± 0.008 (3.5 ± 0.2)
	b	- -	- -	0.197 ± 0.020 (5 ± 0.5)	0.197 ± 0.020 (5 ± 0.5)	0.197 ± 0.020 (5 ± 0.5)	0.197 ± 0.020 (5 ± 0.5)	0.315 ± 0.020 (8 ± 0.5)
	R min.	- -	- -	0.066 (1.7)	0.098 (2.5)	0.098 (2.5)	0.137 (3.5)	0.177 (4.5)
	C max.	- -	- -	0.229 (5.8)	0.276 (7)	0.276 (7)	0.315 (8)	0.355 (9)
	X	- -	- -	0.2 ± 0.020 (5.08 ± 0.5)	0.248 ± 0.020 (6.3 ± 0.5)	0.248 ± 0.020 (6.3 ± 0.5)	0.300 ± 0.020 (7.62 ± 0.5)	0.350 ± 0.020 (8.9 ± 0.5)
	Leads per side	-		2	2	2	2	3
	T max.*	0.154 (3.9)	0.138 (3.5)	0.138 (3.5)	0.2kV up to 3kV: 0.119 (3) 4kV-5kV: 0.150 (3.8)	0.2kV up to 3kV: 0.158 (4) 4kV-5kV: 0.197 (5)	0.2kV up to 3kV: 0.158 (4) 4kV: 0.197 (5) 5kV: 0.237 (6)	0.2kV up to 3kV: 0.158 (4) 4kV: 0.197 (5) 5kV: 0.237 (6)

Dielectric		NPO	X7R	NPO	C4xx	X7R	NPO	C4xx	X7R	NPO	C4xx	X7R	NPO	C4xx	X7R	NPO	C4xx	X7R	NPO	C4xx	X7R
Exxelia ceramic code		1	2	1	4	2	1	4	2	1	4	2	1	4	2	1	4	2	1	4	2
Min. Capacitance value		12pF	120pF	10pF	27pF	100pF	10pF	33pF	150pF	10pF	33pF	150pF	15pF	47pF	150pF	18pF	56pF	150pF	33pF	82pF	330pF
Rated voltage (U_{RC})																					
0.2kV	Standard	-	-	5.6nF	120nF	220nF	12nF	220nF	470nF	12nF	220nF	390nF	15nF	330nF	560nF	18nF	390nF	820nF	33nF	680nF	1.5µF
	Extended	-	-	18nF	-	470nF	27nF	-	-	22nF	-	1µF	39nF	-	-	56nF	-	1.8µF	100nF	-	2.7µF
0.5kV	Standard	-	-	3.3nF	22nF	47nF	6.8nF	47nF	100nF	5.6nF	47nF	100nF	6.8nF	68nF	150nF	8.2nF	82nF	220nF	22nF	120nF	390nF
	Extended	-	-	10nF	39nF	150nF	18nF	68nF	-	18nF	68nF	270nF	22nF	100nF	-	27nF	120nF	560nF	68nF	220nF	1µF
1kV	Standard	-	-	1.8nF	6.8nF	15nF	2.7nF	12nF	22nF	2.2nF	12nF	22nF	3.3nF	18nF	33nF	3.9nF	22nF	47nF	10nF	39nF	68nF
	Extended	820pF	12nF	5.6nF	10nF	27nF	8.2nF	15nF	-	6.8nF	15nF	56nF	10nF	22nF	-	12nF	27nF	120nF	33nF	56nF	220nF
1.5kV	Standard	-	-	820pF	2.7nF	5.6nF	1.2nF	5.6nF	10nF	1.5nF	5.6nF	10nF	2.2nF	8.2nF	15nF	2.7nF	10nF	18nF	4.7nF	18nF	33nF
	Extended	-	-	1.5nF	3.9nF	12nF	2.2nF	8.2nF	-	2.2nF	6.8nF	22nF	3.3nF	12nF	-	4.7nF	15nF	47nF	8.2nF	27nF	82nF
2kV	Standard	-	-	390pF	1.5nF	3.3nF	680pF	2.7nF	5.6nF	470pF	2.7nF	5.6nF	820pF	4.7nF	6.8nF	1.2nF	5.6nF	10nF	3.3nF	10nF	18nF
	Extended	470pF	2.7nF	820pF	2.2nF	5.6nF	1.2nF	3.9nF	-	1nF	3.9nF	12nF	1.8nF	6.8nF	-	2.7nF	8.2nF	27nF	6.8nF	15nF	47nF
3kV	Standard	-	-	180pF	680pF	1.2nF	180pF	1.2nF	2.2nF	220pF	1.2nF	2.2nF	330pF	1.8nF	3.3nF	470pF	2.2nF	3.9nF	820pF	3.9nF	6.8nF
	Extended	220pF	1nF	390pF	1nF	2.7nF	680pF	1.8nF	-	470pF	1.8nF	4.7nF	820pF	2.7nF	-	1nF	3.3nF	12nF	1.8nF	5.6nF	22nF
4kV	Standard	-	-	100pF	330pF	680pF	120pF	680pF	1nF	150pF	820pF	1.2nF	220pF	1.2nF	1.8nF	390pF	1.5nF	2.7nF	680pF	3.3nF	4.7nF
	Extended	150pF	470pF	220pF	560pF	-	330pF	1nF	-	330pF	1.2nF	2.2nF	680pF	1.8nF	-	820pF	2.2nF	4.7nF	1.5nF	4.7nF	10nF
5kV	Standard	-	-	-	-	-	-	-	-	100pF	560pF	820pF	150pF	820pF	1nF	270pF	1nF	1.8nF	470pF	2.2nF	3.3nF
	Extended	-	-	-	-	-	-	-	-	220pF	820pF	1.5nF	320pF	1.2nF	-	560pF	1.5nF	3.3nF	1nF	2.7nF	6.8nF

High Voltage Chips Capacitors

C Series

STANDARD RATINGS

	Size	4040			5440			5550			6560			11283			16080		
	Exxelia size code	83			84			89			85			87			88		
Dimensions inches (mm)	L*	0.400 ± 0.039 (10.16 ±1)			0.539 ± 0.039 (13.7 ± 1)			0.551 ± 0.039 (14 ± 1)			0.650 ± 0.039 (16.5 ± 1)			1.122 ± 0.039 (28.5 ± 1)			1.555 ± 0.039 (39.5 ± 1)		
	W*	0.400 ± 0.039 (10.16 ± 1)			0.400 ± 0.039 (10.16 ± 1)			0.500 ± 0.039 (12.7 ± 1)			0.598 ± 0.039 (15.2 ± 1)			0.827 ± 0.039 (21 ± 1)			0.756 ± 0.039 (19.2 ± 1)		
	a	0.059 ± 0.020 (1.5 ± 0.5)			0.059 ± 0.020 (1.5 ± 0.5)			0.059 ± 0.020 (1.5 ± 0.5)			0.059 ± 0.020 (1.5 ± 0.5)			0.059 ± 0.020 (1.5 ± 0.5)			0.059 ± 0.020 (1.5 ± 0.5)		
	d	0.138 ± 0.008 (3.5 ± 0.2)			0.138 ± 0.008 (3.5 ± 0.2)			0.138 ± 0.008 (3.5 ± 0.2)			0.138 ± 0.008 (3.5 ± 0.2)			0.138 ± 0.008 (3.5 ± 0.2)			0.138 ± 0.008 (3.5 ± 0.2)		
	b	0.315 ± 0.020 (8 ± 0.5)			0.315 ± 0.020 (8 ± 0.5)			0.315 ± 0.020 (8 ± 0.5)			0.591 ± 0.020 (15 ± 0.5)			0.591 ± 0.020 (15 ± 0.5)			0.591 ± 0.020 (15 ± 0.5)		
	R min.	0.275 (7)			0.393 (10)			0.393 (10)			0.511 (13)			0.984 (25)			1.377 (35)		
	C max.	0.473 (12)			0.611 (15.5)			0.63 (16)			0.729 (18.5)			1.26 (32)			1.654 (42)		
	X	0.45 ± 0.020 (11.43 ± 0.5)			0.551 ± 0.020 (14 ± 0.5)			0.563 ± 0.020 (14.3 ± 0.5)			0.7 ± 0.020 (17.78 ± 0.5)			1.15 ± 0.020 (29.21 ± 0.5)			1.6 ± 0.020 (40.64 ± 0.5)		
	Leads per side	4			4			5			6			6			6		
	T max.*	0.2kV up to 3kV: 0.158 (4) 4kV: 0.197 (5) 5kV up to 10kV: 0.237 (6)			0.2kV up to 3kV: 0.158 (4) 4kV: 0.197 (5) 5kV up to 10kV: 0.237 (6)			0.2kV up to 3kV: 0.158 (4) 4kV: 0.197 (5) 5kV up to 10kV: 0.237 (6)			0.2kV up to 3kV: 0.158 (4) 4kV: 0.197 (5) 5kV up to 10kV: 0.237 (6)			0.2kV up to 3kV: 0.158 (4) 4kV: 0.197 (5) 5kV: 0.237 (6) 7.5kV up to 10kV: 0.256 (6.5)			0.2kV up to 3kV: 0.158 (4) 4kV: 0.197 (5) 5kV: 0.236 (6) 7.5kV up to 10kV: 0.256 (6.5)		
Dielectric		NPO	C4xx	X7R	NPO	C4xx	X7R	NPO	C4xx	X7R	NPO	C4xx	X7R	NPO	C4xx	X7R	NPO	C4xx	X7R
Exxelia ceramic code		1	4	2	1	4	2	1	4	2	1	4	2	1	4	2	1	4	2
Min. Capacitance value		10pF	180pF	270pF	22pF	270pF	390pF	27pF	390pF	560pF	47pF	470pF	1nF	120pF	1nF	2.2nF	150pF	1.8nF	2.7nF
Rated voltage (U_{RC})																			
0.2kV	Standard	56nF	1.2µF	2.7µF	82nF	1.5µF	3.9µF	100nF	1.8µF	4.7µF	180nF	2.7µF	6.8µF	330nF	6.8µF	12µF	390nF	8.2µF	15µF
	Extended	180nF	-	5.6µF	270nF	-	6.8µF	220nF	-	8.2µF	560nF	-	12µF	1µF	-	33µF	1.2µF	-	39µF
0.5kV	Standard	33nF	270nF	680nF	47nF	330nF	1µF	56nF	390nF	1.2µF	82nF	680nF	1.8µF	150nF	1.5µF	3.9µF	270nF	1.8µF	4.7µF
	Extended	100nF	390nF	1.5µF	150nF	560nF	2.2µF	150nF	680nF	2.7µF	270nF	1µF	3.9µF	470nF	2.2µF	10µF	820nF	2.7µF	12µF
1kV	Standard	15nF	82nF	150nF	22nF	82nF	220nF	33nF	120nF	270nF	39nF	220nF	390nF	82nF	560nF	1µF	150nF	680nF	1.2µF
	Extended	47nF	120nF	390nF	68nF	120nF	560nF	82nF	220nF	560nF	120nF	330nF	1µF	270nF	680nF	2.7µF	470nF	1µF	3.3µF
1.5kV	Standard	8.2nF	39nF	82nF	12nF	39nF	100nF	15nF	68nF	150nF	22nF	100nF	180nF	47nF	220nF	470nF	68nF	330nF	560nF
	Extended	18nF	56nF	180nF	22nF	56nF	220nF	33nF	100nF	330nF	47nF	150nF	470nF	100nF	330nF	1.2µF	150nF	470nF	1.5µF
2kV	Standard	4.7nF	18nF	33nF	6.8nF	22nF	68nF	8.2nF	39nF	68nF	12nF	56nF	100nF	27nF	120nF	220nF	39nF	180nF	330nF
	Extended	10nF	27nF	100nF	15nF	33nF	150nF	18nF	56nF	150nF	27nF	82nF	220nF	56nF	180nF	560nF	82nF	270nF	820nF
3kV	Standard	1.5nF	8.2nF	15nF	2.7nF	10nF	27nF	3.3nF	18nF	27nF	4.7nF	27nF	39nF	12nF	56nF	100nF	15nF	68nF	120nF
	Extended	3.3nF	12nF	39nF	5.6nF	15nF	56nF	10nF	22nF	68nF	10nF	39nF	100nF	27nF	82nF	270nF	33nF	100nF	330nF
4kV	Standard	1.2nF	6.8nF	10nF	2.2nF	6.8nF	15nF	2.7nF	12nF	18nF	3.9nF	18nF	27nF	10nF	39nF	68nF	12nF	47nF	100nF
	Extended	2.7nF	10nF	18nF	4.7nF	10nF	27nF	6.8nF	18nF	39nF	8.2nF	27nF	47nF	22nF	56nF	120nF	27nF	82nF	150nF
5kV	Standard	1nF	4.7nF	5.6nF	1.8nF	4.7nF	10nF	1.8nF	8.2nF	12nF	3.3nF	12nF	18nF	8.2nF	27nF	56nF	10nF	33nF	68nF
	Extended	2.2nF	6.8nF	15nF	3.9nF	6.8nF	22nF	4.7nF	12nF	27nF	6.8nF	18nF	39nF	15nF	39nF	82nF	18nF	47nF	100nF
7.5kV	Standard	150pF	-	1.5nF	270pF	-	2.7nF	470pF	-	3.3nF	560pF	-	6.8nF	1.5nF	-	18nF	2.2nF	-	27nF
	Extended	330pF	-	3.3nF	560pF	-	5.6nF	1.2nF	-	6.8nF	1.2nF	-	12nF	3.3nF	-	33nF	4.7nF	-	47nF
10kV	Standard	100pF	-	680pF	180pF	-	1.2nF	270pF	-	1.5nF	390pF	-	3.3nF	1nF	-	8.2nF	1.5nF	-	12nF
	Extended	220pF	-	1.8nF	390pF	-	3.3nF	680pF	-	3.9nF	820pF	-	6.8nF	2.2nF	-	15nF	3.3nF	-	27nF

* For E, EW, H and HW: add +0.020 inch (+0.5 mm) to L, W and T dimensions.
The high voltage parts may require varnish or encapsulation to prevent surface arcing.
Available capacitance values:
NP0, C4xx dielectrics: E6, E12, E24 (see page 14). Specific values upon request.
X7R dielectric: E6, E12 in standard (see page 14). Specific values upon request.
The above table defines the standard products, other components may be built upon request.

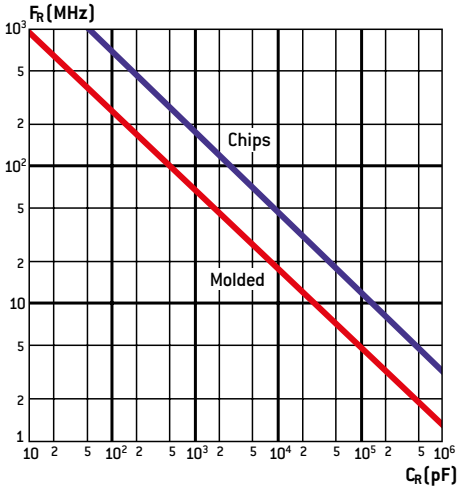
General Information

High voltage multilayer ceramic capacitors designed by EXXELIA are adapted to applications in electronics such as high voltage power supplies and high voltage multiplier circuits. Their multilayer construction offers significant size and space saving advantages. They are available in class 1 (NP0), class 2 (X7R) and C4xx (–2,200 ppm/°C) dielectrics versions complying with the main requirements of applicable standards. They are suited for use in commercial, industrial and High-Rel military and space circuits.

As standard products can't meet all the specificities of all applications, special applications may require specific features (higher voltage, burn-in, dimensions, coating, leading, marking…) not described in this catalogue. Based on our state-of-the-art technologies and our expertise, our Engineers may study at your request all special components to meet your application.

Please, consult us for more information.

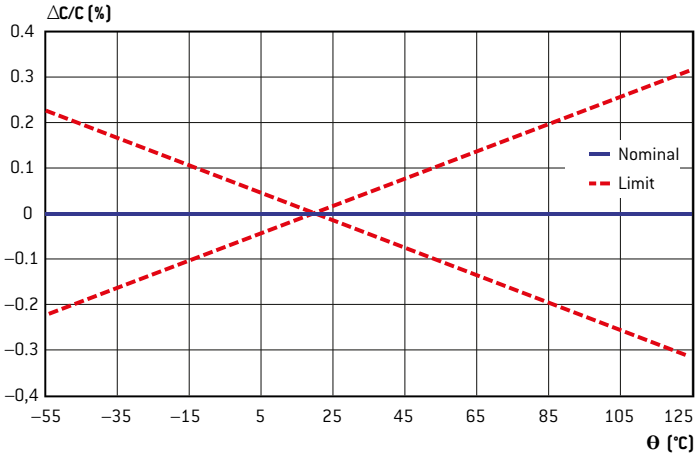
NP0, X7R, C4xx: SELF-RESONANCE FREQUENCE VS CAPACITANCE



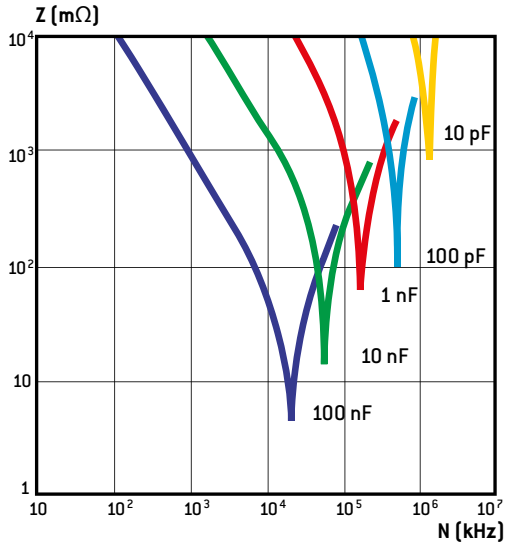
NP0/C0G DIELECTRICS (CLASS 1)

Made of titanium oxide and other various selected oxides, they feature unique stability of all parameters under such constraints as operating time, temperature, voltage applied. For example, the quality factor remains very high over an extremely wide frequency range. As example, loss angle tangent value at 1MHz is typically in the order of 3.10^{-4}. These characteristics make them compatible with steep-edge impulse mode without noticeable temperature rise. The different parameters and related variations are illustrated in figures below:

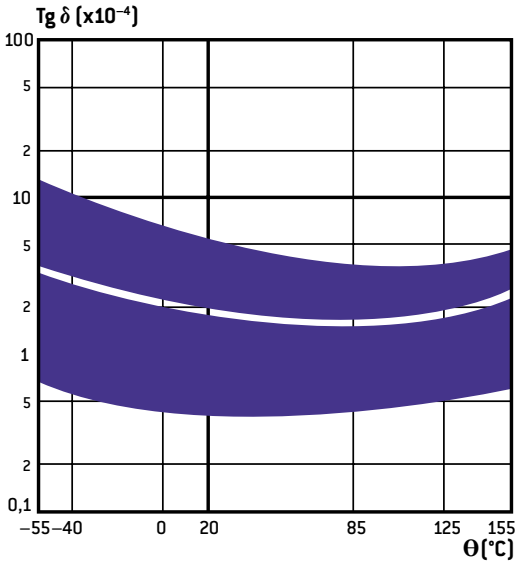
NP0: RELATIVE CAPACITANCE CHANGE VS TEMPERATURE



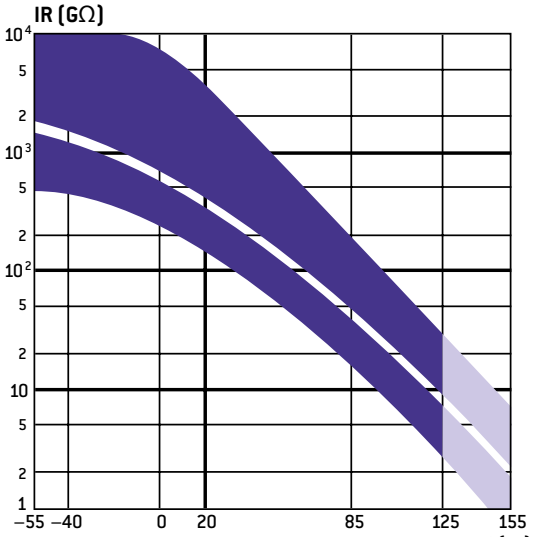
NP0: IMPEDANCE VS FREQUENCY



NP0: LOSS TANGENT VS TEMPERATURE



NP0: INSULATION RESISTANCE VS TEMPERATURE



General Information

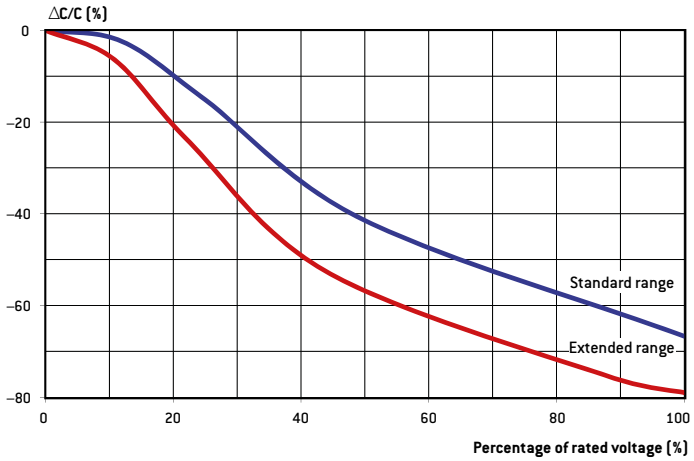
X7R DIELECTRICS (CLASS 2)

They are mainly made of barium titanate modified by various oxides to achieve the electrical properties required. A specific ceramic dielectric is used to achieve an excellent dielectric strength. High dielectric constant enables to achieve high capacitance values.

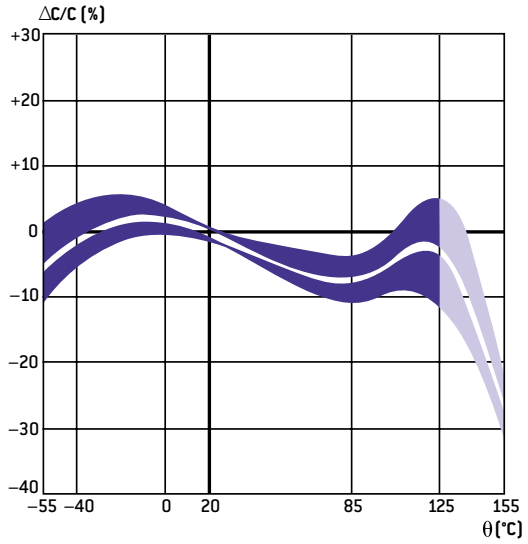
For optimum use, the specific properties of barium titanate in function of the different parameters must be taken into account.

See the variations illustrated in figures below:

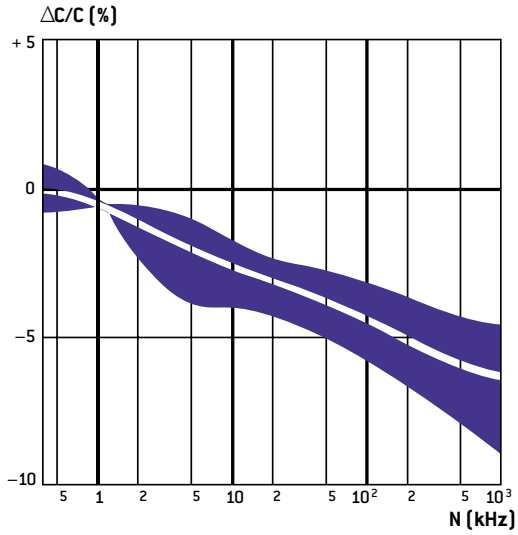
CHANGE VS PERCENTAGE OF RATED VOLTAGE APPLIED



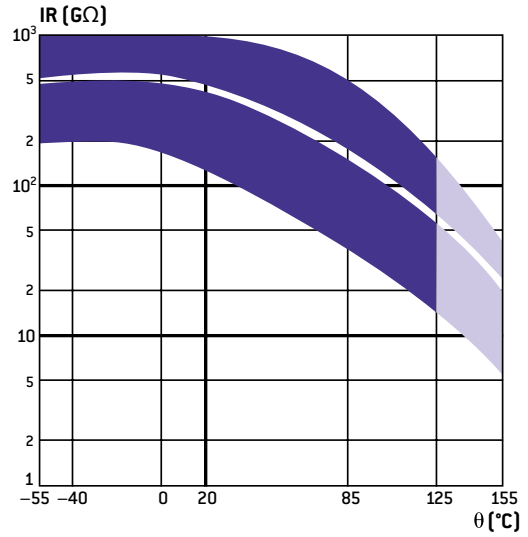
X7R: CAPACITANCE CHANGE VS TEMPERATURE



X7R: CAPACITANCE CHANGE VS FREQUENCY

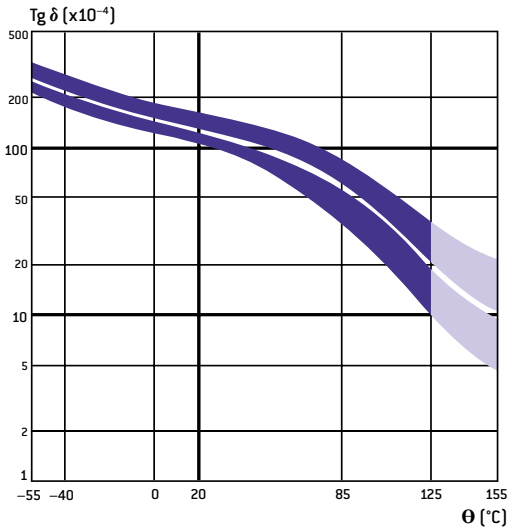


X7R: INSULATION RESISTANCE VS TEMPERATURE

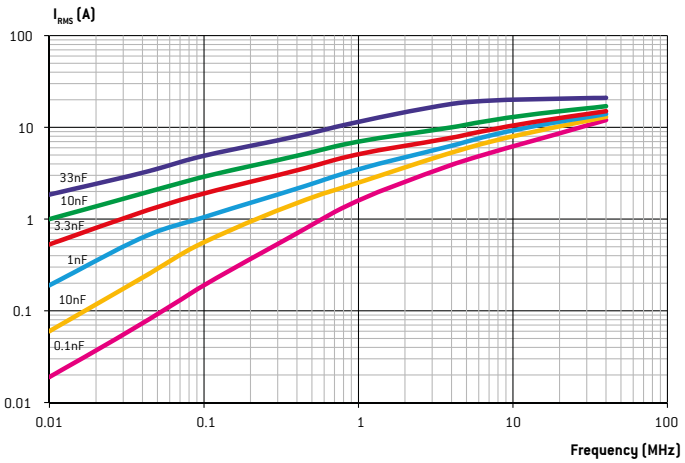


General Information

X7R: LOSS TANGENT CHANGE VS TEMPERATURE



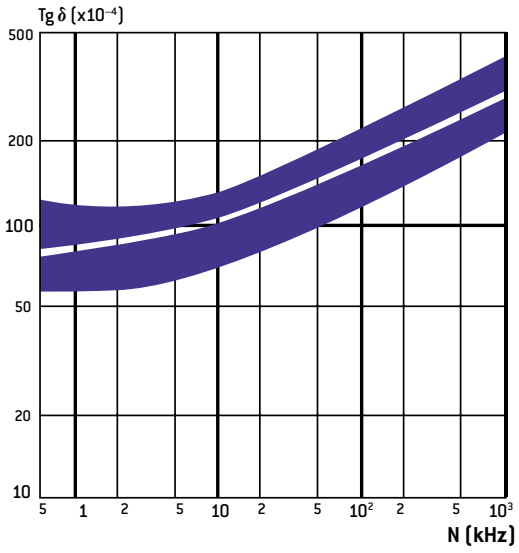
X7R: MAXIMUM ADMISSIBLE CURRENT VS FREQUENCY



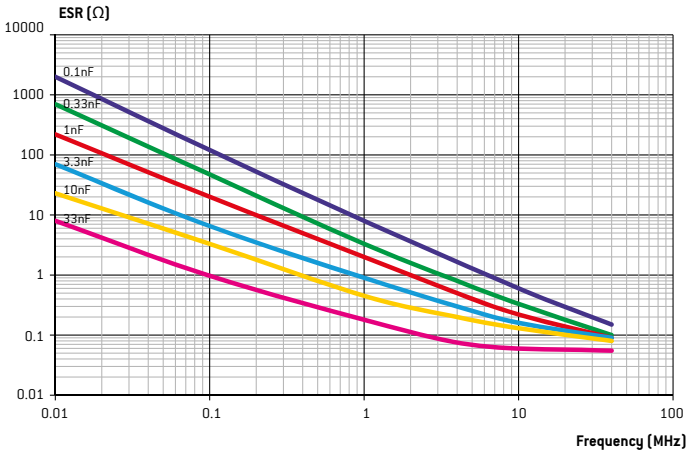
These typical curves are examples of admissible currents for one family of chip capacitors (size 3333). For other curves and products or for further information, please contact us.

Note: for the calculations, we have considered that the terminations are directly connected to an infinite heat sink. In other words, the thermal resistance of the circuit itself which depends on its type and design has not been taken into account. Moreover, the ambient temperature taken is 25°C.

X7R: LOSS TANGENT CHANGE VS FREQUENCY



X7R: ESR VS FREQUENCY

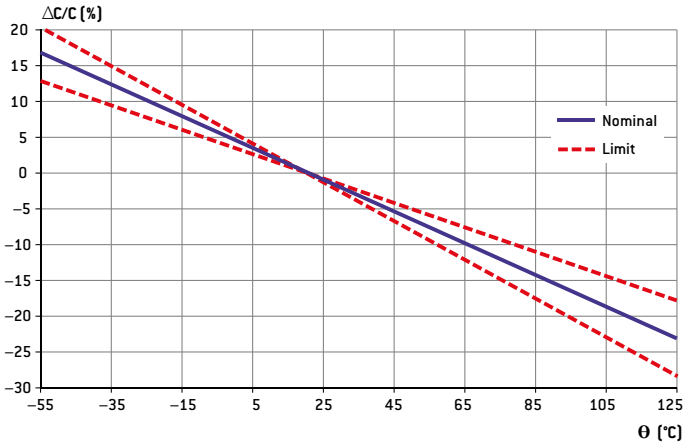


The ESR (Equivalent Serial Resistance) typical curves are given, here for SMD (chip) capacitors. Regarding the curves for the leaded capacitors, they are rather the same. Indeed, due to the resistivity of the raw material used and the wire diameters, the resistance of the wires is much lower than the ESR of the chips. So, in a first approach, their influence can be considered as negligible.

C4xx DIELECTRIC

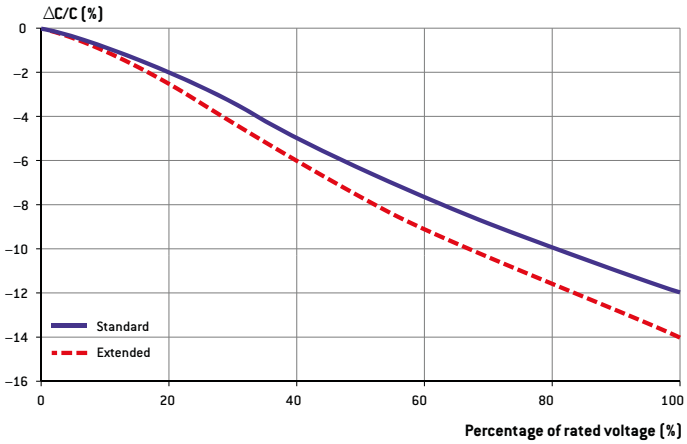
This ceramic is a negative temperature coefficient dielectric (–2,200 ppm/°C). Its advantage is that it combines the high dielectric constant of an X7R dielectric with the stability of an NP0 dielectric. As the C4xx ceramic features low dissipation factor it is recommended for AC line filtering from 110 Vrms to 230 Vrms, 20 to 400 Hz, for high power RF at high voltage up to 5,000 V and for pulse applications.

C4xx: TEMPERATURE COEFFICIENT

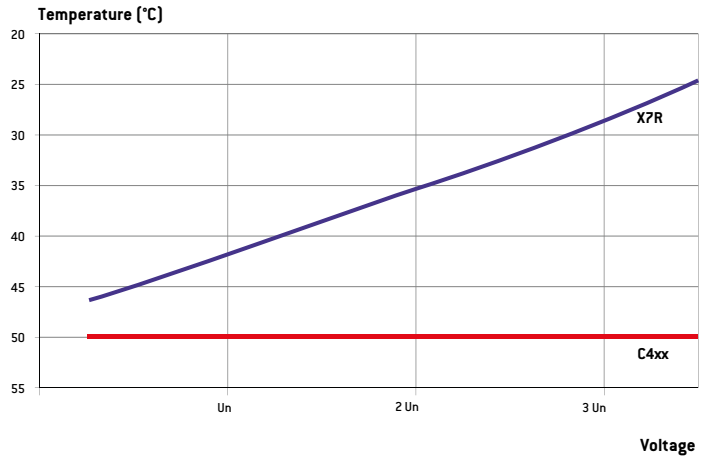


COMPARISON OF CAPACITANCE VALUE UNDER RATED VOLTAGE AT 125°C

C4xx: VOLTAGE COEFFICIENT



COMPARISON OF SELF-HEATING AT 400 Hz BETWEEN C4xx AND X7R DIELECTRICS

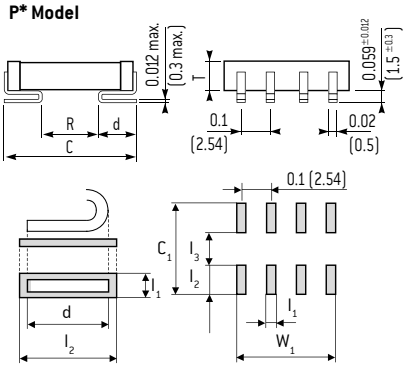


HIGH VOLTAGE

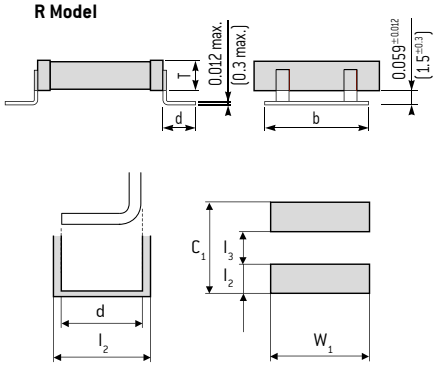
General Information

RECOMMENDED FOOTPRINTS

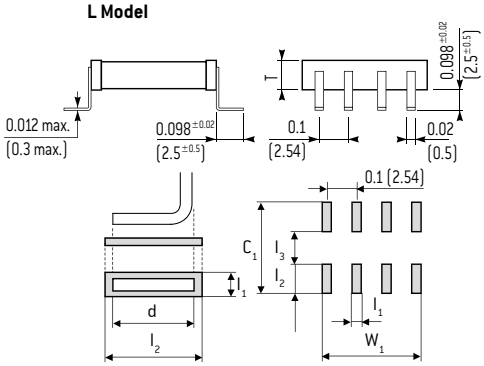
P* Model



R Model



L Model



DIMENSIONS in inches (mm)

Exxelia size code	Lead shape	C max inches (mm)	Leads per side	d inches (mm)	b inches (mm)	C_1 inches (mm)	W_1 inches (mm)	l_1 inches (mm)	l_2 inches (mm)	l_3 inches (mm)
90	P*	0.228 (5.8)	2	0.06 ± 0.012 (1.5 ± 0.3)	- -	0.268 (6.8)	0.147 (3.74)	0.047 (1.2)	0.108 (2.75)	0.098 (2.5)
	L	0.394 (10)	2	0.098 ± 0.02 (2.5 ± 0.5)	- -	0.433 (11)	0.147 (3.74)	0.047 (1.2)	0.152 (3.85)	0.130 (3.3)
	R	0.386 (9.8)	1	0.087 ± 0.008 (2.2 ± 0.2)	0.197 ± 0.02 (5 ± 0.5)	0.425 (10.8)	0.244 (6.2)	- -	0.148 (3.75)	0.130 (3.3)
80	P*	0.276 (7)	2	0.06 ± 0.012 (1.5 ± 0.3)	- -	0.315 (8)	0.147 (3.74)	0.047 (1.2)	0.108 (2.75)	0.098 (2.5)
	L	0.480 (12.2)	2	0.098 ± 0.02 (2.5 ± 0.5)	- -	0.520 (13.2)	0.147 (3.74)	0.047 (1.2)	0.171 (4.35)	0.177 (4.5)
	R	0.433 (11)	1	0.087 ± 0.008 (2.2 ± 0.2)	0.197 ± 0.02 (5 ± 0.5)	0.472 (12)	0.244 (6.2)	- -	0.148 (3.75)	0.177 (4.5)
91	P*	0.276 (7)	2	0.06 ± 0.012 (1.5 ± 0.3)	- -	0.315 (8)	0.147 (3.74)	0.047 (1.2)	0.108 (2.75)	0.098 (2.5)
	L	0.480 (12.2)	2	0.098 ± 0.02 (2.5 ± 0.5)	- -	0.520 (13.2)	0.147 (3.74)	0.047 (1.2)	0.171 (4.35)	0.177 (4.5)
	R	0.433 (11)	1	0.087 ± 0.008 (2.2 ± 0.2)	0.197 ± 0.02 (5 ± 0.5)	0.472 (12)	0.244 (6.2)	- -	0.148 (3.75)	0.177 (4.5)
81	P*	0.315 (8)	2	0.087 ± 0.012 (2.2 ± 0.3)	- -	0.354 (9)	0.147 (3.74)	0.047 (1.2)	0.108 (2.75)	0.138 (3.5)
	L	0.531 (13.5)	2	0.098 ± 0.02 (2.5 ± 0.5)	- -	0.571 (14.5)	0.147 (3.74)	0.047 (1.2)	0.171 (4.35)	0.228 (5.8)
	R	0.484 (12.3)	1	0.087 ± 0.008 (2.2 ± 0.2)	0.197 ± 0.02 (5 ± 0.5)	0.524 (13.3)	0.244 (6.2)	- -	0.148 (3.75)	0.228 (5.8)
82	P*	0.354 (9)	3	0.087 ± 0.012 (2.2 ± 0.3)	- -	0.394 (10)	0.247 (6.28)	0.047 (1.2)	0.108 (2.75)	0.177 (4.5)
	L	0.587 (14.9)	3	0.098 ± 0.02 (2.5 ± 0.5)	- -	0.626 (15.9)	0.247 (6.28)	0.047 (1.2)	0.171 (4.35)	0.283 (7.2)
	R	0.642 (16.3)	1	0.138 ± 0.008 (3.5 ± 0.2)	0.315 ± 0.02 (8 ± 0.5)	0.681 (17.3)	0.362 (9.2)	- -	0.199 (5.05)	0.283 (7.2)
83	P*	0.472 (12)	4	0.087 ± 0.012 (2.2 ± 0.3)	- -	0.512 (13)	0.347 (8.82)	0.047 (1.2)	0.118 (3)	0.276 (7)
	L	0.676 (17.16)	4	0.098 ± 0.02 (2.5 ± 0.5)	- -	0.715 (18.16)	0.347 (8.82)	0.047 (1.2)	0.191 (4.85)	0.333 (8.46)
	R	0.731 (18.56)	1	0.138 ± 0.008 (3.5 ± 0.2)	0.315 ± 0.02 (8 ± 0.5)	0.770 (19.56)	0.362 (9.2)	- -	0.219 (5.55)	0.333 (8.46)
84	P*	0.610 (15.5)	4	0.087 ± 0.012 (2.2 ± 0.3)	- -	0.650 (16.5)	0.347 (8.82)	0.047 (1.2)	0.128 (3.25)	0.394 (10)
	L	0.815 (20.7)	4	0.098 ± 0.02 (2.5 ± 0.5)	- -	0.854 (21.7)	0.347 (8.82)	0.047 (1.2)	0.191 (4.85)	0.472 (12)
	R	0.870 (22.1)	1	0.138 ± 0.008 (3.5 ± 0.2)	0.315 ± 0.02 (8 ± 0.5)	0.909 (23.1)	0.362 (9.2)	- -	0.219 (5.55)	0.472 (12)
89	P*	0.630 (16)	5	0.087 ± 0.012 (2.2 ± 0.3)	- -	0.669 (17)	0.347 (8.82)	0.047 (1.2)	0.128 (3.25)	0.413 (10.5)
	L	0.827 (21)	5	0.098 ± 0.02 (2.5 ± 0.5)	- -	0.866 (22)	0.347 (8.82)	0.047 (1.2)	0.191 (4.85)	0.484 (12.3)
	R	0.882 (22.4)	1	0.138 ± 0.008 (3.5 ± 0.2)	0.315 ± 0.02 (8 ± 0.5)	0.921 (23.4)	0.362 (9.2)	- -	0.219 (5.55)	0.484 (12.3)
85	P*	0.728 (18.5)	6	0.087 ± 0.012 (2.2 ± 0.3)	- -	0.768 (19.5)	0.547 (13.9)	0.047 (1.2)	0.128 (3.25)	0.512 (13)
	L	0.925 (23.5)	6	0.098 ± 0.02 (2.5 ± 0.5)	- -	0.965 (24.5)	0.547 (13.9)	0.047 (1.2)	0.191 (4.85)	0.583 (14.8)
	R	0.980 (24.9)	1	0.138 ± 0.008 (3.5 ± 0.2)	0.591 ± 0.02 (15 ± 0.5)	1.020 (25.9)	0.638 (16.2)	- -	0.219 (5.55)	0.583 (14.8)
87	P*	1.260 (32)	6	0.087 ± 0.012 (2.2 ± 0.3)	- -	1.299 (33)	0.547 (13.9)	0.047 (1.2)	0.128 (3.25)	0.945 (24)
	L	1.398 (35.5)	6	0.098 ± 0.02 (2.5 ± 0.5)	- -	1.437 (36.5)	0.547 (13.9)	0.047 (1.2)	0.191 (4.85)	1.055 (26.8)
	R	1.453 (36.9)	1	0.138 ± 0.008 (3.5 ± 0.2)	0.591 ± 0.02 (15 ± 0.5)	1.492 (37.9)	0.638 (16.2)	- -	0.219 (5.55)	1.055 (26.8)
88	P*	1.654 (42)	6	0.087 ± 0.012 (2.2 ± 0.3)	- -	1.693 (43)	0.547 (13.9)	0.047 (1.2)	0.128 (3.25)	1.378 (35)
	L	1.831 (46.5)	6	0.098 ± 0.02 (2.5 ± 0.5)	- -	1.870 (47.5)	0.547 (13.9)	0.047 (1.2)	0.191 (4.85)	1.488 (37.8)
	R	1.886 (47.9)	1	0.138 ± 0.008 (3.5 ± 0.2)	0.591 ± 0.02 (15 ± 0.5)	1.925 (48.9)	0.638 (16.2)	- -	0.219 (5.55)	1.488 (37.8)

* For PL and PLS, add 0.098 in (2.5 mm) to d and l2 and 0.197 in (5 mm) to C1.

General Information

MATERIALS EXPERT

For 50 years and as a market leader, EXXELIA's comprehensive knowledge of the materials properties and performances have enabled us to design capacitors in Porcelain, NP0, BX, 2C1, BP, X7R and –2200ppm/°C ceramics.

CUSTOM DESIGNS

Our catalog products don't meet your application?

Based on the valuable experience accumulated over the design of 2,000+ specific ceramic capacitors, you can trust EXXELIA to define a qualitative custom solution in a time effective manner.

NO OBSOLESCENCE

Choosing a standard or custom EXXELIA product means you won't have to worry about obsolescence.

TYPICAL APPLICATIONS

- Aerospace & Defense: cockpit panels, flight control, radio systems, missile guidance systems…
- Space: military and commercial satellites, launcher…
- Medical: MRI, external defibrillators, implantable devices…
- Telecommunications: base stations…
- Oil and gas: drilling tools, MWD, LWD, wellheads…

ISO 9001 AND AS9100C

Quality is at the core of Exxelia's corporate culture. Each sites has its own certifications.

CERTIFICATIONS

Capacitors manufactured by EXXELIA comply with American and European standards and meet the requirements of many international standards.
For Space qualified parts (ESA QPL), please refer to our catalog «Ceramic capacitors for Space applications».

QUALITY & RELIABILITY

EXXELIA is committed to design and manufacture high quality and reliability products. The test cycles reproducing the most adverse operating conditions over extended periods (up to 10 000 hours) have logged to date well over 5.10^9 hours/°Component.
Failure rate data can be provided upon request.

CONFLICT MINERALS

EXXELIA is committed to an approach based on «Conflict Minerals Compliance». This US SEC rule demands complete traceability and a control mechanism for the mineral procurement chain, encouraging importers to buy only «certified» ore.
We have discontinued relations with suppliers that procure from the Democratic Republic of the Congo or an adjoining country.

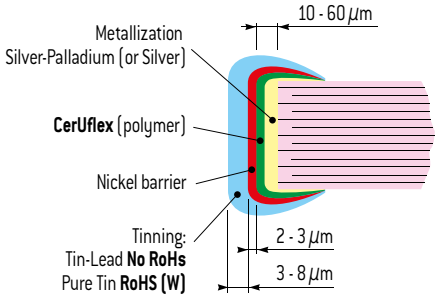
ENVIRONMENT

EXXELIA is committed to applying a robust environmental policy, from product design through to shipment. To control its environmental footprint and reconcile this with the company' functional imperatives, our environmental policy provides for the reduction or elimination of hazardous substances. We also focus on compliance with European Union directives and regulations, notably REACH and RoHS.

RoHS COMPLIANCY

SMD CAPACITORS

The capacitor terminations are generally protected by a nickel barrier formed by electrolytic deposit. This barrier gives chip capacitors leaching performance far exceeding the requirements of all applicable standards. The nickel barrier guarantees a minimum resistance to soldering heat for a period of 1 minute at 260°C in a tin-lead (60/40) or tin-lead-silver (62/36/2) bath without noticeable alteration to the solderability. It also allows repeated soldering-unsoldering and the longer soldering times required by reflow techniques.
However nickel barrier amplifies thermal shock and is not recommended for chip sizes equal or greater than CNC Y (30 30) - (C 282 to C 288 - CNC 80 to CNC 94).



LEADED COMPONENTS

As well as for SMD products, leaded capacitors ranges can also be RoHS. These products, which are characterized by the suffix «W» added to the commercial type, are naturally compatible with the soldering alloys used in RoHS mounting technology. The connections coating is generally an alloy SnAg (with a maximum of 4% Ag). However, on a few products that EXXELIA will precise on request, the coating is pure silver.

Selection Guide

Main Characteristic	Model	Size	Dielectric	Voltage	Capacitance	Temperature	Coating: Uncoated	Coating: Varnished	Coating: Conformal coated	Coating: Molded	Coating: Self-protected	Leads: DIL	Leads: Ribbon	Leads: Axial	Leads: Radial	Mounting: SMD	Mounting: Through hole	Main Applications	Page
STANDARD	**CEC / CNC SERIES** Low and Medium Voltage Chips Capacitors	0402 to 3040	NP0 BX 2C1 X7R	10V to 1,000V	1pF to 12µF	−55°C to +125°C	●									●		Precision, stability, decoupling	22
	NON MAGNETIC CHIPS SERIES Low and Medium Voltage Chips Capacitors	0505 to 2220	NP0 X7R	50V to 500V	10pF to 1µF	−55°C to +125°C	●									●		Precision, stability, decoupling	26
	OP SERIES Open Mode Chips Capacitors	0805 to 2220	NP0 X7R	10V to 100V	1pF to 4.7µF	−55°C to +125°C	●									●		Precision, stability, decoupling. Significantly reduce risk of short circuit	28
	CER /CNR SERIES Low Inductance Chips Capacitors	0306 to 0612	NP0 X7R	16V to 100V	1pF to 270nF	−55°C to +125°C	●									●		Decoupling, low ESL, medical embedded	30
	C3N / C4N / C3E / C4E SERIES Capacitors Arrays	-	NP0 X7R	25V to 200V	4.7pF to 33nF	−55°C to +125°C	●									●		Medical embedded, miniaturisation	32
	30 S4 SERIES Safety Capacitors	-	NP0 X7R	40V to 100V	470pF to 820nF	−55°C to +125°C	●						●			●		Railway	33
	TCE / TCX / TCN / TXR MOLDED SERIES Radial Molded Capacitors	-	NP0 BX 2C1 X7R	25V to 500V	1pF to 4.7µF	−55°C to +125°C				●					●		●	Precision, stability, decoupling	34
	LA SERIES Radial Molded Capacitors	-	NP0 Temp. coeff.	25V to 63V	1pF to 680nF	−55°C to +125°C				●					●		●	Decoupling	36
	TCE / TCX / TCN / TXR AXIAL SERIES Axial Molded Capacitors	-	NP0 BX - 2C1 X7R	25V to 500V	1pF to 3.9µF	−55°C to +125°C				●				●			●	Precision, stability, decoupling	38
	TCE / TCX / TCN / TXR CONFORMAL COATED SERIES Radial Dipped Capacitors	-	NP0 BX - 2C1 X7R	25V to 500V	1pF to 6.8µF	−55°C to +125°C			●						●		●	Precision, stability, decoupling	40
	NON MAGNETIC CONFORMAL COATED SERIES Radial Dipped Capacitors	-	NP0 X7R	63V to 500V	180pF to 1µF	−55°C to +125°C			●						●		●	Precision, stability, decoupling	42
	CK SERIES Radial Molded Capacitors	-	BX	25V to 250V	10pF to 1µF	−55°C to +125°C				●					●		●	Decoupling	44
HIGH VOLTAGE	**C Series** High voltage chips Capacitors	1812 to 16080	NP0 C4xx X7R	200V to 10kV	10pF to 39µF	−55°C to +125°C	●									●		Power supply, voltage multiplier, radars. • aerospace • space • defence • railways	51
	TCL / TCK Series High voltage Molded & Varnished leaded Capacitors	-	NP0 C4xx X7R	200V to 10kV	10pF to 39µF	−55°C to +125°C		●		●					●		●		54
	TCF Series High voltage Conformal coated leaded Capacitors	-	NP0 C4xx X7R	200V to 10kV	10pF to 39µF	−55°C to +125°C			●						●		●		57
	TKD Series High voltage Conformal coated leaded Capacitors	-	NP0 C4xx X7R	200V to 10kV	10pF to 39µF	−55°C to +125°C			●						●		●		60
	CS Series High voltage Stacked Capacitors	2220 to 16080	NP0 C4xx X7R	1kV to 10kV	220pF to 15µF	−55°C to +125°C	●	●				●	●			●	●		62

Selection Guide

Main Characteristic	Model		Size range	Dielectric	Voltage range	Capacitance range	Temperature range	Coating					Leads				Mounting		Main Applications	Page
								Uncoated	Varnished	Conformal coated	Molded	Self protected	DIL	Ribbon	Axial	Radial	SMD	Through hole		
HIGH CAPACITANCE	**R SERIES (CHIPS)** High Capacitance Chips Capacitors		2225 to 45107	X7R	50V to 500V	47nF to 27µF	−55°C to +125°C	●									●		Switch Mode Power Supply, filtering, smoothing, decoupling. • aerospace • space • defence	73
	R SERIES (LEADED) Radial Leaded Conformal Coated Capacitors		-	X7R	50V to 500V	47nF to 27µF	−55°C to +125°C			●						●		●		77
	TEF SERIES Radial Leaded Conformal Coated Capacitors		-	NP0	63V to 500V	10nF to 680nF	−55°C to +125°C			●						●		●		80
	SV / SC SERIES High Capacitance Stacked Capacitors		2225 to 125205	X7R	50V to 500V	47nF to 390µF	−55°C to +125°C	●	●				●	●			●	●		81
	CNC3X SERIES High Capacitance Stacked Capacitors		2220 to 4040	X7R	16V to 25V	1.2µF to 68µF	−55°C to +125°C	●	●				●				●	●		88
	CEC5X SERIES High Capacitance Stacked Capacitors		3033 to 80150	NP0	63V to 500V	10nF to 6.8µF	−55°C to +125°C	●	●				●				●	●		90
	TEP / TEV SERIES High Capacitance Stacked Capacitors		-	NP0	63V to 500V	10nF to 6.8µF	−55°C to +125°C		●							●		●		93
	TCN8X SERIES High Capacitance Molded Stacked Capacitors		-	X7R	63V to 500V	0.47µF to 120µF	−55°C to +125°C				●						●			95
HIGH TEMPERATURE	**CE / CN SERIES** High Temperature Chips Capacitors		0402 to 3040	NP0 X7R	16V to 100V	1pF to 8.2µF	−55°C to +250°C	●									●		Oil drilling, motor control, braking systems.	100
	SCT SERIES High Temperature Stacked Capacitors		2225 to 125205	X7R	50V to 500V	47nF to 390µF	−55°C to +215°C	●	●				●				●	●		102
	TCE / TCN MOLDED SERIES HT High Temperature Molded Capacitors		-	NP0 X7R	16V to 100V	1pF to 10µF	−55°C to +220°C				●				●	●		●		107
	TCE / TCN SELF-PROTECTED SERIES High Temperature Self-Protected Capacitors		-	NP0 X7R	25V to 500V	10pF to 3.9µF	−55°C to +250°C					●			●	●		●		109
	TCH SERIES High Temperature High Voltage Capacitors		-	NP0 X7R	200V to 10kV	10pF to 15µF	−55°C to +250°C		●							●		●		111
FEED-THRU	**TBC SERIES** Discoidal Capacitors		-	NP0 X7R	25V to 1kV	10pF to 12µF	−55°C to +125°C	●									●		Very low ESL	115
	BPM SERIES Planar Array		-	X7R	25V to 200V	330pF to 68nF	−55°C to +125°C	●									●		Very low ESL, miniaturisation	117

Selection Guide

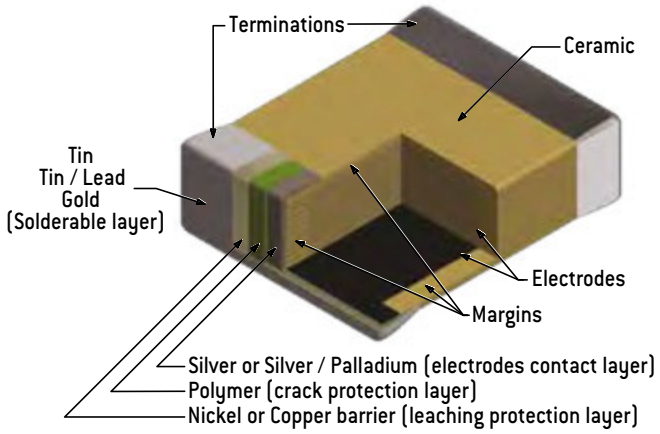
Main Characteristic	Model	Size range	Dielectric	Voltage range	Capacitance range	Temperature range	Coating: Uncoated	Coating: Varnished	Coating: Conformal coated	Coating: Molded	Coating: Self protected	Leads: DIL	Leads: Ribbon	Leads: Axial	Leads: Radial	Mounting: SMD	Mounting: Through hole	Main Applications	Page
HIGH Q	**XBL SERIES** Broadband	0402	X7R	16V	100nF	−55°C to +125°C	●									●		DC Blocking, Coupling, Bypassing	138
	UBL SERIES Broadband	0402	X7R	16V	100nF	−55°C to +125°C	●									●			140
	UBZ SERIES Broadband	0201	X5R X6T	10V	100nF	−55°C to +105°C	●									●			142
	CH SERIES Classic HiQ	0505 1111	P100	50V to 1.5kV	0.1pF to 1nF	−55°C to +175°C	●						●		●	●		Cellular base station amplifier, MRI.	144
	SH SERIES Super HiQ	0402 to 1210	NP0	25V to 1.5kV	0.2pF to 1nF	−55°C to +150°C	●						●		●	●		Cellular base station equipment Broadband Point to point/ multi-point radios RF generators	147
	SHD / SHR SERIES Reverse Geometry	0709 0711	NP0	500V	0.5pF to 100pF	−55°C to +175°C	●									●			150
	NHB SERIES High Self Resonant Frequency	1111	NP0	500V	0.3pF to 100pF	−55°C to +175°C	●									●			152
	CP SERIES High Power	2225 4040	P100	200V to 7kV	1pF to 10nF	−55°C to +125°C	●		●				●	●	●	●	●	RF power amplifier Plasma chamber MRI coils	154
	CL SERIES High Power	2225 to 7065	NP0	200V to 7kV	1pF to 10nF	−55°C to +125°C	●		●				●	●	●	●	●	RF power amplifier Plasma chamber MRI coils	158

ADDITIONAL AVAILABLE RANGES (consult our website)

STANDARD	**TCE1X Series**	-	NP0	63V to 100V	0,5pF to 10nF	−55°C to +125°C				●					●		●	Precision, stability, decoupling	-
	TCN19 Series	-	2C1	63V to 250V	10pF to 1µF	−55°C to +125°C				●					●		●	Decoupling	-
	TCN3X Series	-	2C1	50V to 100V	100pF to 1,8µF	−55°C to +125°C				●					●		●		-
	LA6 Series	-	2C1	25V to 63V	100pF to 1µF	−55°C to +125°C				●					●		●		-
HIGH VOLT.	**H Series**	0805 to 6560	NP0 X7R	1kV to 10kV	2pF to 390nF	−55°C to +125°C	●		●						●	●	●	Power supply, voltage multiplier, radars.	-
HIGH CAPACITANCE	**CNC5X Series**	3033 to 80150	X7R	63V to 500V	0,1µF to 180µF	−55°C to +125°C	●	●				●				●	●	Switch Mode Power Supply, filtering, smoothing, decoupling. • aerospace • space • defence	-
	CNC8X Series (chips)	3033 to 33110	X7R	63V to 400V	47nF to 27µF	−55°C to +125°C	●									●			-
	CNC8X Series (DIL)	3333 to 80150	X7R	63V to 400V	47nF to 180µF	−55°C to +125°C	●	●				●				●	●		-
	TCP / TCV8X Series	3333 to 80150	X7R	63V to 400V	47nF to 180µF	−55°C to +125°C		●							●		●		-
	TCP / TCV5X Series	3033 to 80150	X7R	63V to 500V	0,1µF to 180µF	−55°C to +125°C		●							●		●		-
	TCF Series	-	X7R	63V to 500V	0,1µF to 18µF	−55°C to +125°C			●							●	●		-
HIGH TEMP.	**CNC25X Series**	3033 to 5550	X7R	50V	1µF to 33µF	−55°C to +200°C	●	●				●				●	●	Oil drilling, motor control, braking systems.	-
HIGH Q	**CNW Series**	-	X7R	100V to 300V	10nF to 1µF	−55°C to +125°C	●						●	●		●	●	Power amplifier	-
	SPT519 / CAW CEW Series	-	NP0	100V to 300V	10nF to 1µF	−55°C to +125°C	●	●					●	●		●	●		-

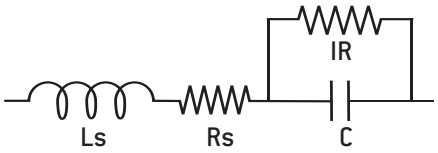
Ceramic Capacitors Technology

MLCC STRUCTURE



EQUIVALENT CIRCUIT

Capacitor is a complex component combining resistive, inductive and capacitive phenomena. A simplified schematic for the equivalent circuit is:



DIELECTRIC CHARACTERISTICS

Insulation Resistance (IR) is the resistance measured under DC voltage across the terminals of the capacitor and consists principally of the parallel resistance shown in the equivalent circuit. As capacitance values and hence the area of dielectric increases, the IR decreases and hence the product (C x IR) is often specified in Ω.F or MΩ.μF.

The Equivalent Series Resistance (ESR) is the sum of the resistive terms which generate heating when capacitor is used under AC voltage at a given frequency (f).

Dissipation factor (DF) is the ration of the apparent power input will turn to heat in the capacitor:

$DF = 2\pi f C ESR$

When a capacitor works under AC voltage, **heat power loss (P),** expressed in Watt, is equal to:

$P = 2\pi f C Vrms^2 DF$

The series inductance (Ls) is due to the currents running through the electrodes. It can distort the operation of the capacitor at high frequency where the **impedance (Z)** is given as:

$Z = Rs + j (Ls.\omega - 1/(C.\omega))$ with $\omega = 2\pi f$

When frequency rises, the capacitive component of capacitors is gradually canceled up to the resonance frequency, where :

$Z = Rs$ and $LsC.\omega^2 = 1$

Above this frequency the capacitor behaves like an inductor.

	P100	NP0	N2200 (C4xx)	BX	2C1	X7R
Dielectric material	Porcelain	Magnesium titanate or Neodynium baryum titanate	Barium zirconate titanate	Baryum titanate ($BaTiO_3$)		
Dielectric constant	15 – 18	20 – 85	450	2,000 – 5,000		
Electrode technology	PME (Precious Metal Electrodes): Ag/Pd					
Capacitance variation between –55°C and +125/°C without DC voltage	(100±30)ppm/°C	(0±30)ppm/°C	(–2,200±500) ppm/°C	±15%	±20%	±15%
Capacitance variation between –55°C and +125/°C with DC rated voltage			0 -15%	15% –25%	20% –30%	Not applicable
Piezo-electric effect	None		None	Yes		
Dielectric absorption	None		Few %	Few %		
Thermal shock sensitive	+		+	++		

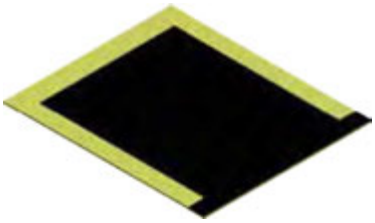
Ceramic Capacitors Technology

MANUFACTURING STEPS

SLIP CASTING

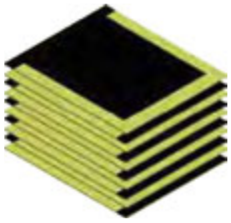
A slurry, a mix of ceramic powder, binder and solvents, is poured onto conveyor belt inside a drying oven, resulting in a dry ceramic sheet.

ELECTRODE SCREEN PRINTING



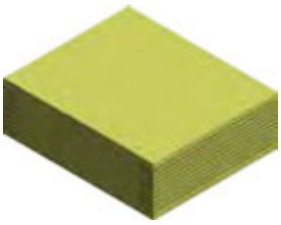
The electrode ink, made from a metal powder mixed with solvents, is printed onto the ceramic sheets using a screen printing process.

STACKING



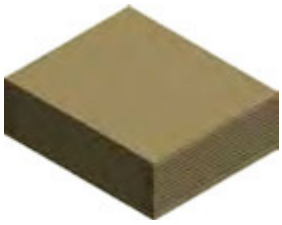
The sheets with electrode printed are stacked to create a multilayer structure.

PRESSING



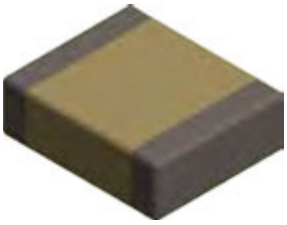
Pressure is applied to the stack to fuse all the separate layers, this created a monolithic structure.

SINTERING



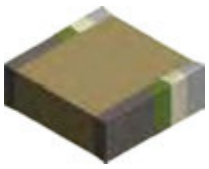
The parts are sintered in an oven with a precise temperature profile which is very important to the characteristics of the capacitors.

TERMINATIONS



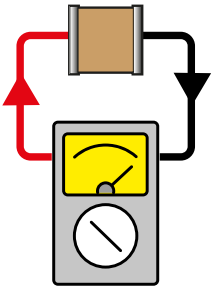
Each terminal of the capacitor is dipped in the termination ink, mix of metal powder, solvents and glass frit and the parts are fired in an oven.

TERMINATIONS PLATING



Stacking + leads soldering + encapsulation
(see pages 10-11)

FINAL TESTING



PACKAGING

User Guide

SMD TERMINATIONS

NON RoHS COMPLIANT	Code	RoHS COMPLIANT	Code	Magnetic	Recommended mounting process						Storage (months)*
					Epoxy bonding	Iron soldering	Wave soldering	Vapor phase soldering	Infrared soldering	Wire bonding	
Ag	**Q**	Ag	**QW / P**	No	●	●	●	●			18
Ag/Pd/Pt	**-**	Ag/Pd/Pt	**W / A**	No	●	●	●				24
Ag + Ni + dipped Sn/Pb 60/40	**T****	-	**-**	No		●	●	●	●		24
Ag/Pd/Pt + dipped Sn/Pb 60/40	**H**	Ag/Pd/Pt + dipped Sn	**HW**	No		●					24
Ag + Ni + electrolytic Sn/Pb 95/5	**C**	Ag + Ni + electrolytic Sn	**CW / S**	Yes		●	●	●	●		18
Ag + Ni + electrolytic Sn/Pb 60/40	**D**	-	**-**	Yes		●	●	●	●		18
-	**-**	Ag + Cu + electrolytic Sn	**C*****	No		●	●	●	●		18
Ag + Ni + dipped Sn/Pb 60/40	**E**	Ag + Ni + electrolytic Sn	**EW**	Yes		●	●				24
Ag + Ni + Au	**G**	Ag + Ni + Au	**GW**	Yes	●	●	●	●	●	●	36
Ag + Polymer + Ni + Sn/Pb 95/5	**YC**	Ag + Polymer + Ni + Sn	**YCW**	Yes		●	●	●	●		18
Ag + Polymer + Ni + Sn/Pb 60/40	**YD**	-	**-**	Yes		●	●	●	●		18
Ag + Polymer + Ni + Au	**YG**	Ag + Polymer + Ni + Au	**YGW**	Yes	●	●	●	●	●	●	36

Nickel (Ni) or Copper (Cu) barriers amplify thermal shock and are not recommended for chip sizes larger than 3030.

* Storage must be in a dry environment at a temperature of 20°C with a relative humidity below 50%, or preferably in a package enclosing a desiccant.
** Maintenance only.
*** Non magnetic chips series only.

SMD ENVIRONMENTAL TESTS

Ceramic chip capacitors for SMD are designed to meet test requirements of **CECC 32100** and **NF C 93133** standards as specified below in compliance with **NF C 20700** and **IEC 68** standards:

- Solderability: **NF C 20758,** 260°C, bath 62/36/2.
- Adherence: 5N force.
- Vibration fatigue test: **NF C 20706,** 20 g, 10 Hz to 2,000 Hz, 12 cycles of 20 minutes each.
- Rapid temperature change: **NF C 20714,** –55°C to + 125°C, 5 cycles.
- Combined climatic test: **IEC 68-2-38.**
- Damp heat: **NF C 20703,** 93 %, H.R., 40°C.
- Endurance test: 1,000 hours, 1.5 U_{RC}, 125°C.

STORAGE OF CHIP CAPACITORS

TINNED OR NON TINNED CHIP CAPACITORS

Storage must be in a dry environment at a temperature of 20°C with a relative humidity below 50 %, or preferably in a packaging enclosing a desiccant.

STORAGE IN INDUSTRIAL ENVIRONMENT:

- 2 years for tin dipped chip capacitors,
- 18 months for tin electroplated chip capacitors,
- 2 years for non tinned chip capacitors,
- 3 years for gold plated chip capacitors.

STORAGE IN CONTROLLED NEUTRAL NITROGEN ENVIRONMENT:

- 4 years for tin dipped or electroplated chip capacitors,
- 4 years for non tinned chip capacitors,
- 5 years for gold plated chip capacitors.

Storage duration should be considered from delivery date and not from batch manufacture date. The tests carried out at final acceptance stage (solderability, susceptibility to solder heat) enable to assess the compatibility to surface mounting of the chips.

User Guide

LEAD STYLES

SURFACE MOUNTING

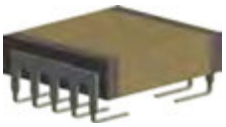
DIL LEADS

P style

PL style

L style

J style



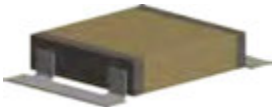
RIBBON LEADS

Micro-strip (type 1)
Short Micro-strip (type 1S)

Axial (Type 2)

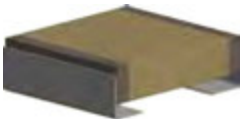
Radial (Type 3)

R style



RX style

RJ style



Please contact Exxelia sales for any lead configuration not shown.

TROUGH-HOLE MOUNTING

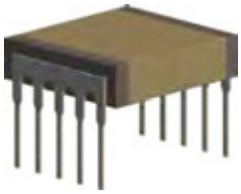
AXIAL AND RADIAL

Radial leads (Type 6)

Radial leads (4 leads)

Axial leads (Type 7)

DIL leads: N style



ENCAPSULATION STYLES

Ceramic encapsulation
(selfprotected)

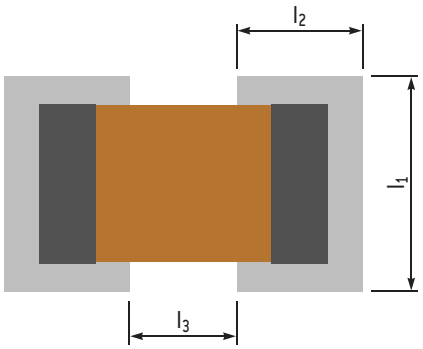
Varnish

Conformal coating

Molding

User Guide

SOLDERING ADVICES FOR REFLOW SOLDERING



Large chips above size 2225 are not recommended to be mounted on epoxy board due to thermal expansion coefficient mismatch between ceramic capacitor and epoxy. Where larger sizes are required, it is recommended to use components with ribbon or other adapted leads so as to absorb thermo-mechanical strains.

Dimensions in inches (in mm)	Reflow soldering						Wave soldering					
	I_1		I_2		I_3		I_1		I_2		I_3	
0402	0.043	(1.1)	0.035	(0.9)	0.012	(0.3)	0.043	(1.1)	0.047	(1.2)	0.012	(0.3)
0403	0.055	(1.4)	0.035	(0.9)	0.012	(0.3)	0.055	(1.4)	0.047	(1.2)	0.012	(0.3)
0504	0.063	(1.6)	0.051	(1.3)	0.016	(0.4)	0.063	(1.6)	0.063	(1.6)	0.016	(0.4)
0603	0.055	(1.4)	0.059	(1.5)	0.02	(0.5)	0.055	(1.4)	0.071	(1.8)	0.02	(0.5)
0805	0.073	(1.85)	0.065	(1.65)	0.024	(0.6)	0.073	(1.85)	0.077	(1.95)	0.024	(0.6)
0907	0.094	(2.4)	0.065	(1.65)	0.035	(0.9)	0.094	(2.4)	0.077	(1.95)	0.035	(0.9)
1005	0.073	(1.85)	0.067	(1.7)	0.039	(1)	0.073	(1.85)	0.079	(2)	0.039	(1)
1206	0.083	(2.1)	0.067	(1.7)	0.059	(1.5)	0.083	(2.1)	0.079	(2)	0.059	(1.5)
1210	0.118	(3)	0.069	(1.75)	0.059	(1.5)	0.118	(3)	0.081	(2.05)	0.059	(1.5)
1605	0.073	(1.85)	0.071	(1.8)	0.087	(2.2)	0.073	(1.85)	0.083	(2.1)	0.087	(2.2)
1806	0.087	(2.2)	0.073	(1.85)	0.102	(2.6)	0.087	(2.2)	0.085	(2.15)	0.102	(2.6)
1812	0.152	(3.85)	0.073	(1.85)	0.102	(2.6)	0.152	(3.85)	0.085	(2.15)	0.102	(2.6)
1825	0.281	(7.15)	0.073	(1.85)	0.102	(2.6)	0.281	(7.15)	0.085	(2.15)	0.102	(2.6)
2210	0.13	(3.3)	0.079	(2)	0.146	(3.7)	0.13	(3.3)	0.091	(2.3)	0.146	(3.7)
2220	0.228	(5.8)	0.079	(2)	0.146	(3.7)	0.228	(5.8)	0.091	(2.3)	0.146	(3.7)
2225	0.281	(7.15)	0.079	(2)	0.146	(3.7)	0.281	(7.15)	0.091	(2.3)	0.146	(3.7)

RECOMMENDED FOOTPRINT FOR SMD CAPACITORS

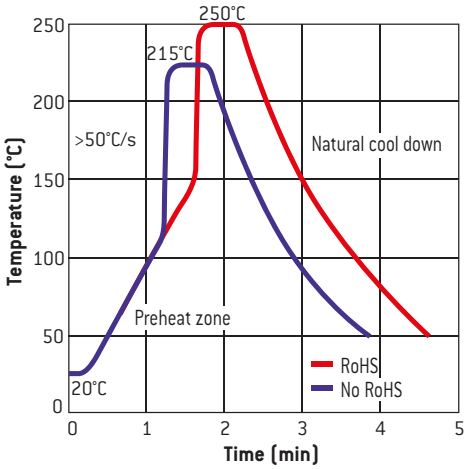
Ceramic is by nature a material which is sensitive both thermally and mechanically. Stresses caused by the physical and thermal properties of the capacitors, substrates and solders are attenuated by the leads.

Wave soldering is unsuitable for sizes larger than 2220 and for the higher ends of capacitance ranges due to possible thermal shock (capacitance values given upon request).

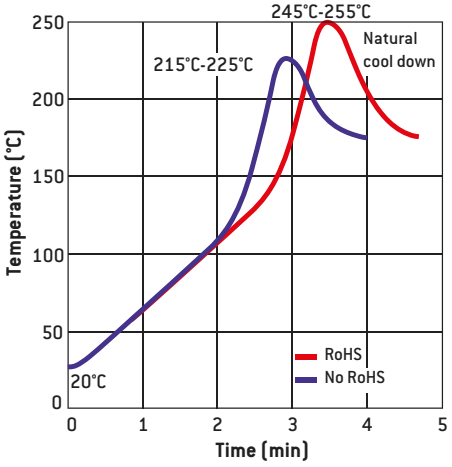
Infrared and vapor phase reflow, are preferred for high reliability applications as inherent thermo-mechanical strains are lower than those inherent to wave soldering.

Whatever the soldering process is, it is highly recommended to apply a thermal cycle, see hereafter our recommended soldering profile:

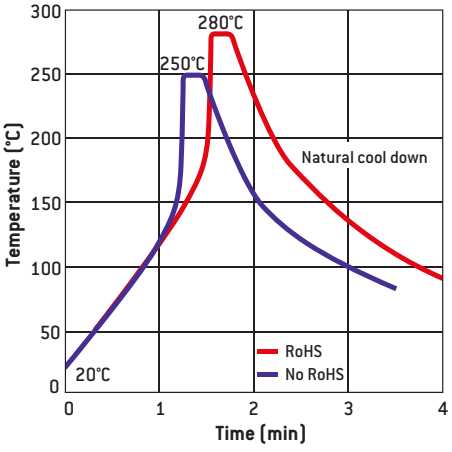
RECOMMENDED VAPOR PHASE REFLOW PROFILE



RECOMMENDED IR REFLOW PROFIL



RECOMMENDED WAVE SOLDERING PROFILE



SOLDERING ADVICES FOR IRON SOLDERING

Attachment with a soldering iron is discouraged due to ceramic brittleness and the process control limitations. In the event that a soldering iron must be used, the following precautions should be observed:

- Use a substrate with chip footprints big enough to allow putting side by side one end of the capacitor and the iron tip without any contact between this tip and the component,
- place the capacitor on this footprint,
- heat the substrate until the capacitor's temperature reaches 150°C minimum (preheating step, maximum 1°C per second),
- place the hot iron tip (a flat tip is preferred) on the footprint **without touching the capacitor.** Use a regulated iron with a 30 watts maximum power. The recommended temperature of the iron is 270 ±10°C. The temperature gap between the capacitor and the iron tip must not exceed 120°C,

- leave the tip on the footprint for a few seconds in order to increase locally the footprint's temperature,
- use a cored wire solder and put it down on the iron tip. In a preferred way use Sn/Pb/Ag 62/36/2 alloy,
- wait until the solder fillet is formed on the capacitor's termination,
- take away iron and wire solder,
- wait a few minutes so that the substrate and capacitor come back down to the preheating temperature,
- solder the second termination using the same procedure as the first,
- let the soldered component cool down slowly to avoid any thermal shock.

PACKAGING

TAPE AND REEL

The films used on the reels correspond to standard IEC 60286-3. Films are delivered on reels in compliance with document IEC 286-3 dated 1991.

Minimum quantity is 250 chips.

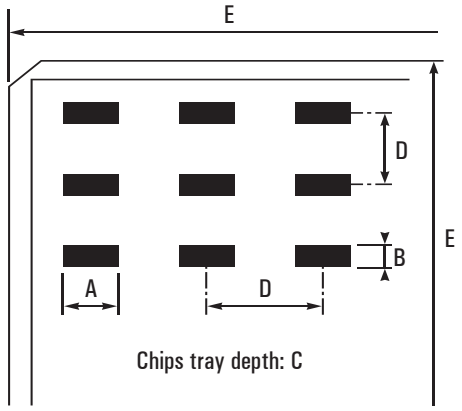
Maximum quantities per reel are as follows:

- Super 8 reel - Ø 180: 2,500 chips.
- Super 8 reel - Ø 330: 10,000 chips.
- Super 12 reel - Ø 180: 1,000 chips.

Reel marking complies with CECC 32100 standard:

- Model.
- Rated capacitance.
- Capacitance tolerance.
- Rated voltage.
- Batch number.

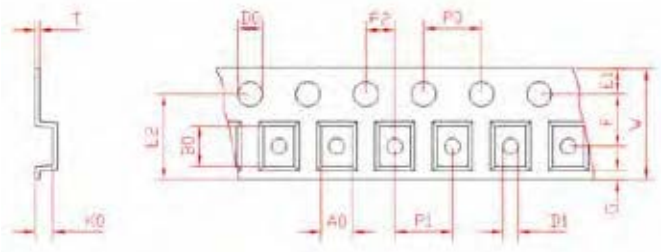
TRAY PACKAGES



DIMENSIONAL CHARACTERISTICS OF CHIPS TRAY PACKAGES

Sizes	Nr. of chips/ package	Oriented chips	Dimensions in inches (in mm)				
			A	B	C	D	E
0402	100	No	Ø 0.112 (Ø 3.02)		0.065 (1.65)	0.167 (4.24)	2 (50.8)
0403	100	No	Ø 0.112 (Ø 3.02)		0.065 (1.65)	0.167 (4.24)	2 (50.8)
0504	100	Yes	0.059 (1.5)	0.045 (1.14)	0.035 (0.89)	0.167 (4.24)	2 (50.8)
0603	340	Yes	0.1 (2.54)	0.06 (1.52)	0.045 (1.14)	0.167 (4.24)	2 (50.8)
0805	100	Yes	0.1 (2.54)	0.06 (1.52)	0.045 (1.14)	0.167 (4.24)	2 (50.8)
1206	100	No	0.14 (3.56)	0.14 (3.56)	0.06 (1.52)	0.167 (4.24)	2 (50.8)
1210	100	Yes	0.14 (3.56)	0.14 (3.56)	0.06 (1.52)	0.167 (4.24)	2 (50.8)
1812	100	No	0.25 (6.35)	0.25 (6.35)	0.13 (3.3)	0.345 (8.76)	4 (101.6)
	25	Yes	0.24 (6.1)	0.265 (6.73)	0.07 (1.78)	0.345 (8.76)	2 (50.8)
2220	100	Yes	0.25 (6.35)	0.25 (6.35)	0.13 (3.3)	0.345 (8.76)	4 (101.6)
	25	Yes	0.24 (6.1)	0.265 (6.73)	0.07 (1.78)	0.345 (8.76)	2(50.8)

HIGH Q CAPACITORS TAPE AND REEL PACKAGING SPECIFICATIONS



Sizes	Type (1)	W±0.3 inches (mm)	F ±0.05 inches (mm)	P1 ±0.1 inches (mm)	T max. inches (mm)	Reel Size inches (mm)	Quantity per Reel
A (0505)	H	0,315 (8)	0,138 (3.5)	0,157 (4)	0,010 (0,25)	7,087 (180)	3'000
A (0505)	V	0,315 (8)	0,138 (3.5)	0,157 (4)	0,010 (0,25)	7,087 (180)	3'000
S (0603)	H	0,315 (8)	0,138 (3.5)	0,157 (4)	0,016 (0,4)	7,087 (180)	4'000
F (0805)	H	0,315 (8)	0,138 (3.5)	0,157 (4)	0,016 (0,4)	7,087 (180)	4'000
B (1111)	H	0,315 (8)	0,138 (3.5)	0,157 (4)	0,012 (0,3)	7,087 (180)	1'000
B (1111)	V	0,315 (8)	0,138 (3.5)	0,157 (4)	0,010 (0,25)	7,087 (180)	1'000
X (2225)	H	0,472 (12)	0,138 (5.5)	0,472 (12)	0,018 (0,45)	12,992 (330)	500
E (4040)	H	0,945 (24)	0,453 ±0,004 (11.5 ±0.1)	0,630 (16)	0,018 (0,45)	12,992 (330)	700
E (4040)	V	1,260 (32)	0,559 ±0,004 (14.2 ±0.1)	0,945 (24)	0,022 (0,55)	15 (381)	350

(1): Horizontal (H) or Vertical (V) orientation in cavities.

User Guide

EIA STANDARD CAPACITANCE VALUES

Following EIA standard, the values and multiples that are indicated in the chart below can be ordered. E48, E96 series and intermediary values are available upon request.

E6 (± 20%)	E12 (± 10%)	E24 (± 5%)
10	10	10
		11
	12	12
		13
15	15	15
		16
	18	18
		20
22	22	22
		24
	27	27
		30
33	33	33
		36
	39	39
		43
47	47	47
		51
	56	56
		62
68	68	68
		75
	82	82
		91

PART MARKING VOLTAGE CODES

Use the following voltage code chart for part markings:

Voltage (V)	Code	Letter code
25	250	A
40	400	B
50	500	C
63	630	D
100	101	E
200	201	G
250	251	H
400	401	K
500	501	L
1,000	102	M
2,000	202	P
3,000	302	R
4,000	402	S
5,000	502	T
7,500	752	U
10,000	103	W

EIA CAPACITANCE CODE

The capacitance is expressed in three digit codes and in units of pico Farads (pF). The first and second digits are significant figures of the capacitance value and the third digit identifies the multiplier.

For capacitance value < 10pF, R designates a decimal point.
See examples below:

EIA code	Capacitance value		
	in pF	in nF	in µF
2R2	2.2	0.0022	0.0000022
6R8	6.8	0.0068	0.0000068
220	22	0.022	0.000022
470	47	0.047	0.000047
181	180	0.18	0.00018
221	220	0.22	0.00022
102	1,000	1	0.001
272	2,700	2.7	0.0027
123	12,000	12	0.012
683	68,000	68	0.068
124	120,000	120	0.12
564	560,000	560	0.56
335	3,300,000	3,300	3.3
825	8,200,000	8,200	8.2
156	15,000,000	15,000	15
686	68,000,000	68,000	68
107	100,000,000	100,000	100
227	220,000,000	220,000	220

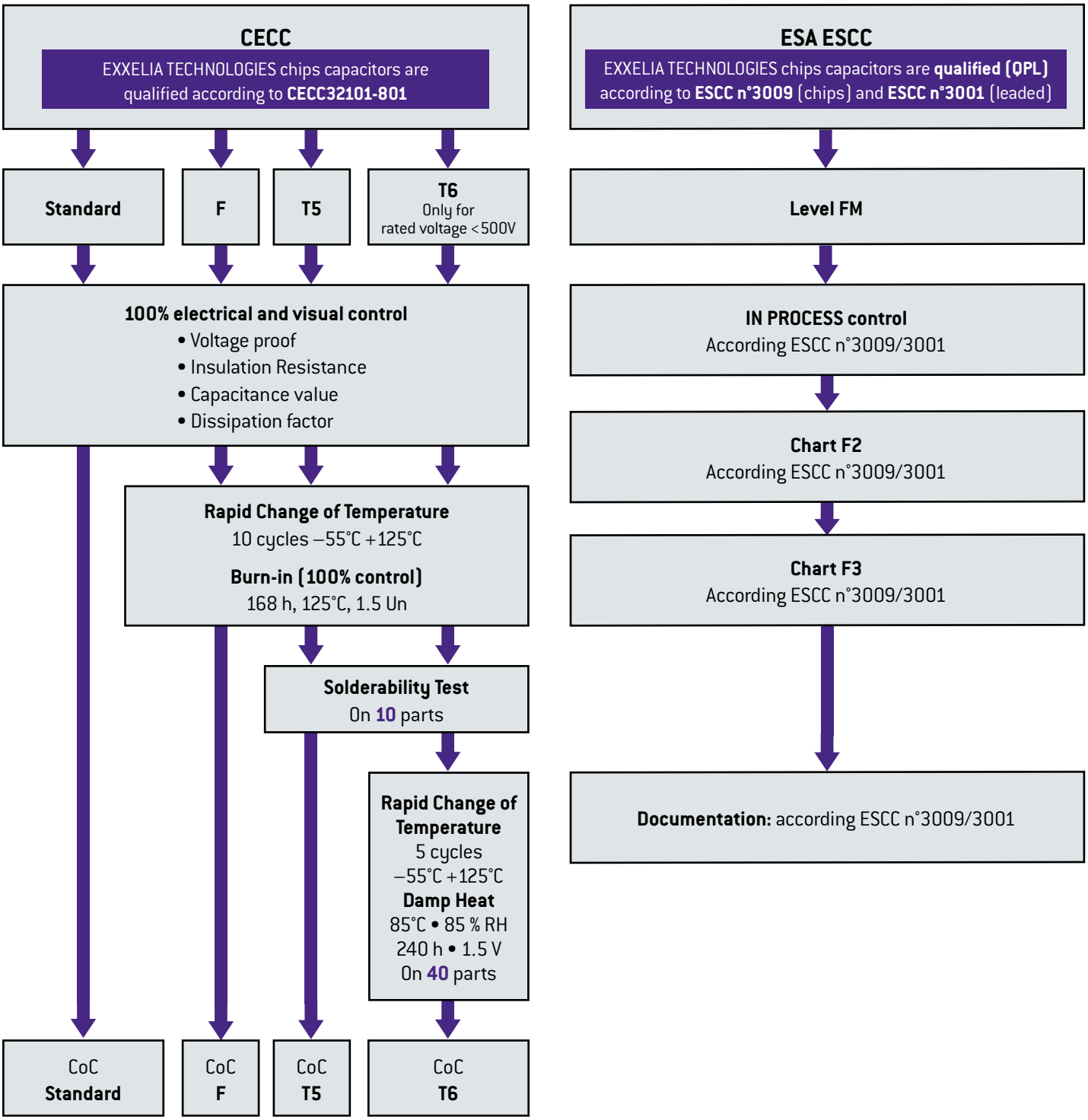
PART MARKING TOLERANCE CODES

Use the following tolerance code chart for part markings:

Tolerance	Letter code
±0.25pF	CU
±0.5pF	DU
±1pF	FU
±1%	F
±2%	G
±5%	J
±10%	K
±20%	M

RELIABILITY LEVELS

Exxelia proposes different reliability levels for the ceramic capacitors for both NP0 and X7R ceramics.



As the world's leading manufacturer of specific passive components, we stand apart through our ability to quickly evaluate the application specific engineering challenges and provide a cost-effective and efficient solutions.

For requirements that cannot be met by catalog products, we offer leading edge solutions in custom configuration: custom geometries, packaging, characteristics, all is possible thanks to our extensive experience and robust development process, while maintaining the highest level of reliability.

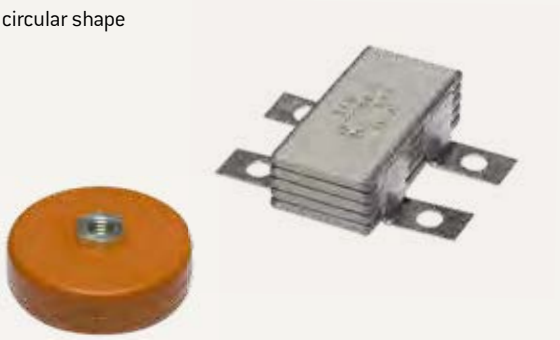
Where necessary, special testing is done to verify requirements, such as low dielectric absorption, ultra-high insulation resistance, low dissipation factor, stability under temperature cycling or under specified environmental conditions, etc.

HIGH CAPACITANCE

- High energy density
- Specific case sizes
- Specific shape of connections (high resistance to vibrations)

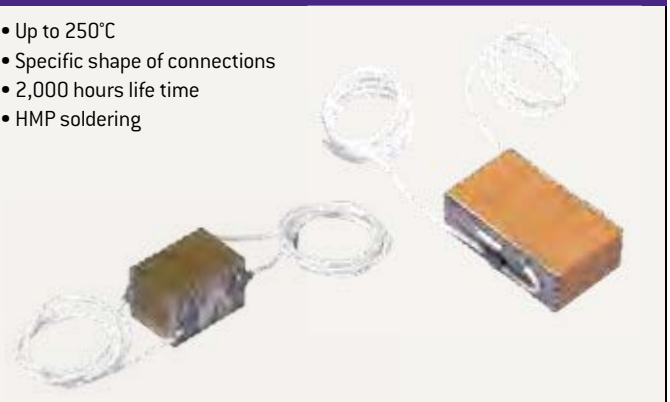
HIGH VOLTAGE

- Up to 50 kV
- Specific circular shape



HIGH TEMPERATURE

- Up to 250°C
- Specific shape of connections
- 2,000 hours life time
- HMP soldering



OTHERS

- Screen printed resistors
- Complex components
- Full functions available